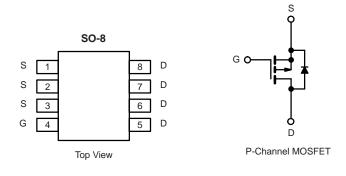


## STS10P4LLF6-VB Datasheet

P-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
- 40	0.010 at $V_{GS}$ = - 10 V	- 16.1	33 nC			
	0.014 at V <sub>GS</sub> = - 4.5 V	- 13.3	33110			



#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

#### APPLICATIONS

- Load Switch
- POL

**ABSOLUTE MAXIMUM RATINGS**  $T_A = 25 \text{ °C}$ , unless otherwise noted Parameter Symbol Limit Unit Drain-Source Voltage - 40 V<sub>DS</sub> V Gate-Source Voltage V<sub>GS</sub> ± 20 T<sub>C</sub> = 25 °C - 16.1 T<sub>C</sub> = 70 °C - 12.9 Continuous Drain Current (T<sub>J</sub> = 150 °C)  $I_D$ T<sub>A</sub> = 25 °C - 10.2<sup>b, c</sup> T<sub>A</sub> = 70 °C - 8.2<sup>b, c</sup> А **Pulsed Drain Current** - 50  $I_{DM}$ T<sub>C</sub> = 25 °C - 5.3  $I_{S}$ Continous Source-Drain Diode Current T<sub>A</sub> = 25 °C - 2.1<sup>b, c</sup> Single Pulse Avalanche Current - 28 I<sub>AS</sub> L = 0.1 mHSingle Pulse Avalanche Energy E<sub>AS</sub> 39 mJ T<sub>C</sub> = 25 °C 6.3 T<sub>C</sub> = 70 °C 4 Maximum Power Dissipation  $P_D$ W T<sub>A</sub> = 25 °C 2.5<sup>b, c</sup> T<sub>A</sub> = 70 °C 1.6<sup>b, c</sup> T<sub>J</sub>, T<sub>stg</sub> °C Operating Junction and Storage Temperature Range - 55 to 150

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	37	50	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	16	20	- C/W	

Notes:

a. Based on  $T_C = 25$  °C. b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 85 °C/W.

服务热线:400-655-8788

# COMPLIANT

HALOGEN

FREE

1

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•			<u> </u>		1	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = - 250 μA	- 40			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	- Ι <sub>D</sub> = - 250 μΑ		- 36		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	i <sub>D</sub> = - 250 μA		5			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	- 1.2		- 2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zana Oata Maltana Drain Ourrant	I <sub>DSS</sub>	V <sub>DS</sub> = - 40 V, V <sub>GS</sub> = 0 V			- 1	μA	
Zero Gate Voltage Drain Current		$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			- 5		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \leq$ - 5 V, $V_{GS}$ = - 10 V	- 25			А	
	D	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 10.2 A		0.010	Ω		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 8.4 A		0.014			
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 10.2 A		37		S	
Dynamic <sup>b</sup>						<b></b>	
Input Capacitance	C <sub>iss</sub>			3007			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V, f = 1 MHz		335		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			291			
Total Gate Charge		$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = -10 \text{ V}, \text{ I}_{D} = -10.2 \text{ A}$		64	95	_	
				33	50	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = - 20 V, $V_{GS}$ = - 4.5 V, $I_{D}$ = - 10.2 A		9.8			
Gate-Drain Charge	Q <sub>gd</sub>			15.7			
Gate Resistance	Rg	f = 1 MHz	0.4	2	4	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			57	86		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 20 V, $R_L$ = 2.4 $\Omega$		50	75	- ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong$ - 8.2 A, $\text{V}_\text{GEN}$ = - 4.5 V, $\text{R}_\text{g}$ = 1 $\Omega$		40	60		
Fall Time	t <sub>f</sub>			17	26		
Turn-On Delay Time	t <sub>d(on)</sub>			13	20		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 20 V, $R_L$ = 2.4 $\Omega$		11	20		
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong$ - 8.2 A, $\text{V}_\text{GEN}$ = - 10 V, $\text{R}_\text{g}$ = 1 $\Omega$		45	68		
Fall Time	t <sub>f</sub>			9	18		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			- 5.3	A	
Pulse Diode Forward Current	I <sub>SM</sub>				- 50		
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 8.2 A, V <sub>GS</sub> = 0 V		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			36	54	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = - 8.2 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		41	62	nC	
Reverse Recovery Fall Time	ta			20		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			16			

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

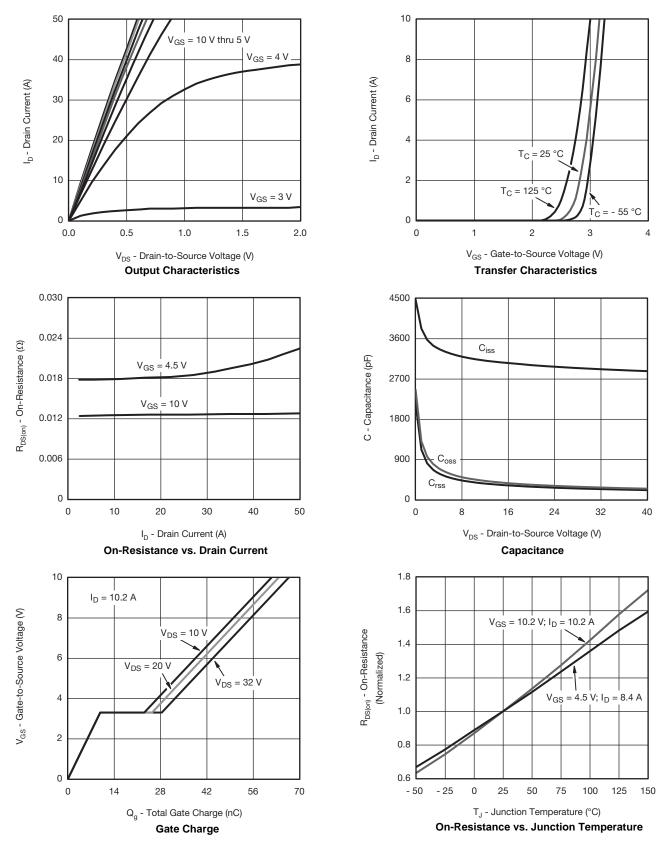
Bsemi

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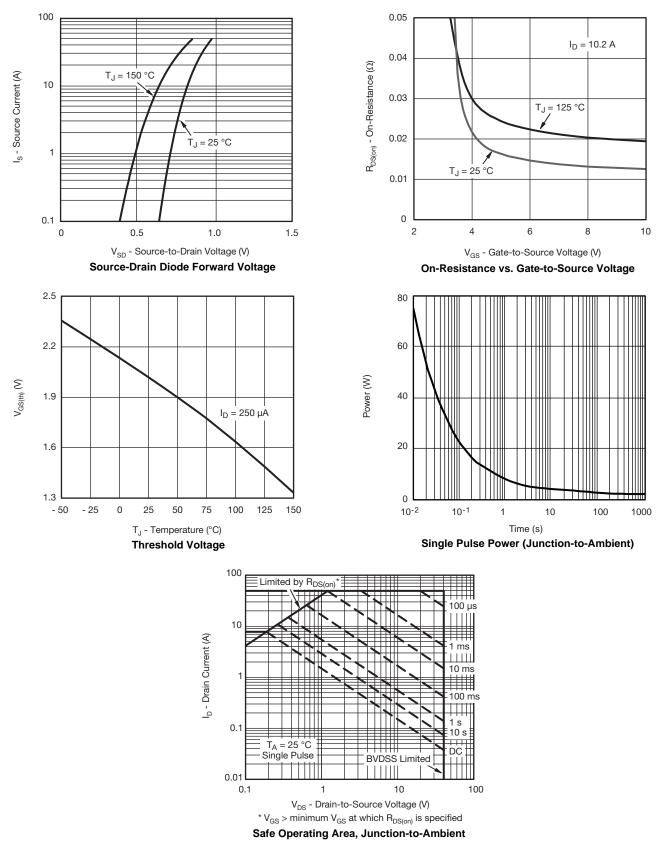
### STS10P4LLF6-VB







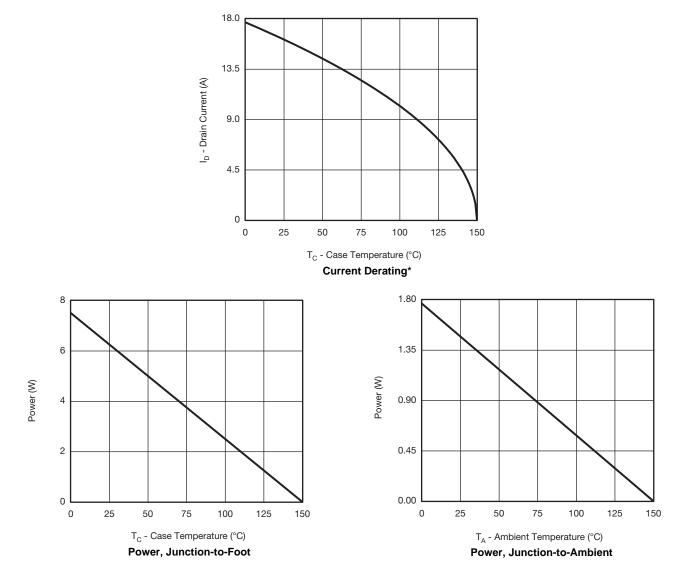




#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



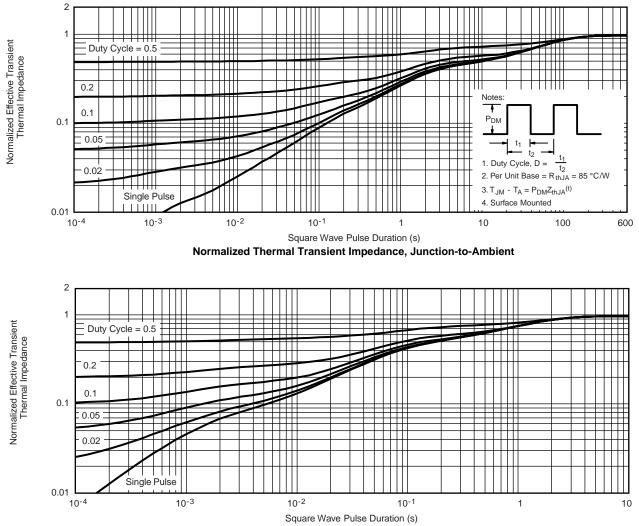
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

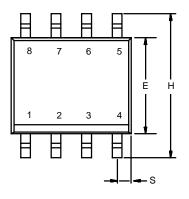


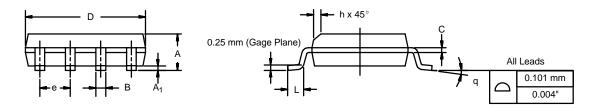
Normalized Thermal Transient Impedance, Junction-to-Foot



#### SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

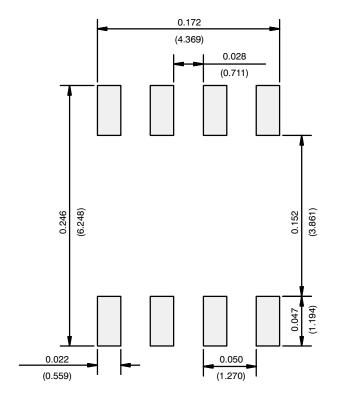




	MILLIMETERS		INCHES		
DIM	Min	Max	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)



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